# **IMAQ**<sup>TM</sup>

# IMAQ PCI/PXI<sup>™</sup>-1409 User Manual

High-Quality Monochrome Image Acquisition Boards for PCI, PXI, and CompactPCI Bus



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### FCC/Canada Radio Frequency Interference Compliance\*

#### **Determining FCC Class**

The Federal Communications Commission (FCC) has rules to protect wireless communications from interference. The FCC places digital electronics into two classes. These classes are known as Class A (for use in industrial-commercial locations only) or Class B (for use in residential or commercial locations). Depending on where it is operated, this product could be subject to restrictions in the FCC rules. (In Canada, the Department of Communications (DOC), of Industry Canada, regulates wireless interference in much the same way.)

Digital electronics emit weak signals during normal operation that can affect radio, television, or other wireless products. By examining the product you purchased, you can determine the FCC Class and therefore which of the two FCC/DOC Warnings apply in the following sections. (Some products may not be labeled at all for FCC; if so, the reader should then assume these are Class A devices.)

FCC Class A products only display a simple warning statement of one paragraph in length regarding interference and undesired operation. Most of our products are FCC Class A. The FCC rules have restrictions regarding the locations where FCC Class A products can be operated.

FCC Class B products display either a FCC ID code, starting with the letters **EXN**, or the FCC Class B compliance mark that appears as shown here on the right.

Consult the FCC web site http://www.fcc.gov for more information.



#### FCC/DOC Warnings

This equipment generates and uses radio frequency energy and, if not installed and used in strict accordance with the instructions in this manual and the CE Mark Declaration of Conformity\*\*, may cause interference to radio and television reception. Classification requirements are the same for the Federal Communications Commission (FCC) and the Canadian Department of Communications (DOC).

Changes or modifications not expressly approved by National Instruments could void the user's authority to operate the equipment under the FCC Rules.

#### Class A

#### **Federal Communications Commission**

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

#### Canadian Department of Communications

This Class A digital apparatus meets all requirements of the Canadian Interference-Causing Equipment Regulations.

Cet appareil numérique de la classe A respecte toutes les exigences du Règlement sur le matériel brouilleur du Canada.

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#### **Federal Communications Commission**

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.

- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### **Canadian Department of Communications**

 $This\ Class\ B\ digital\ apparatus\ meets\ all\ requirements\ of\ the\ Canadian\ Interference-Causing\ Equipment\ Regulations.$ 

Cet appareil numérique de la classe B respecte toutes les exigences du Règlement sur le matériel brouilleur du Canada.

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Readers in the EU/EEC/EEA must refer to the Manufacturer's Declaration of Conformity (DoC) for information\*\* pertaining to the CE Mark compliance scheme. The Manufacturer includes a DoC for most every hardware product except for those bought for OEMs, if also available from an original manufacturer that also markets in the EU, or where compliance is not required as for electrically benign apparatus or cables.

- \* Certain exemptions may apply in the USA, see FCC Rules §15.103 **Exempted devices**, and §15.105(c). Also available in sections of CFR 47.
- \*\* The CE Mark Declaration of Conformity will contain important supplementary information and instructions for the user or installer.

# **Conventions**

italic

The following conventions are used in this manual:

◆ The ◆ symbol indicates that the following text applies only to a specific product, a specific operating system, or a specific software version.

This icon denotes a note, which alerts you to important information.

This icon denotes a warning, which advises you of precautions to take to avoid being electrically shocked.

Italic text denotes variables, emphasis, a cross reference, or an introduction to a key concept. This font also denotes text that is a placeholder for a word or value that you must supply.

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# Introduction

This chapter describes the PCI-1409 and PXI-1409 devices and describes your software programming choices.

### **About Your 1409 Device**

The PCI-1409 and PXI-1409 devices are high-accuracy, monochrome, IMAQ boards for PCI, PXI, or CompactPCI chassis that support RS-170, CCIR, NTSC, and PAL video standards as well as some nonstandard cameras from any of four input sources. The boards feature a 10-bit analog-to-digital converter (ADC) that converts video signals to digital formats. The PCI-1409 acquires images in real time and can store these images in onboard frame memory or transfer these images directly to system memory.

The 1409 device is simple to configure so that you can easily install the board and begin your image acquisition. The 1409 device ships with NI-IMAQ, the National Instruments complete image acquisition driver software you can use to directly control your 1409 device. Using NI-IMAQ, you can quickly and easily start your application without having to program the board at the register level.

Featuring low cost and high accuracy, the 1409 device is ideal for both industrial and scientific environments. As a standalone board, the 1409 device supports four general purpose control lines that you can configure to generate precise timing signals for controlling camera acquisition. The 1409 device also supports four video sources and four external I/O lines that you can use as triggers or digital I/O lines. If you require more advanced triggering or additional I/O lines (either digital or analog), you can use the 1409 device and NI-IMAQ with the National Instruments data acquisition (DAQ) product line.

A common problem with many image acquisition boards is that you cannot easily synchronize several functions to a common trigger or timing event. The 1409 device uses its Real-Time System Integration (RTSI) bus to solve this problem. The RTSI bus consists of the National Instruments RTSI bus

interface and ribbon cable to route additional timing and trigger signals between the 1409 device and up to four National Instruments DAQ, Motion Control, or other IMAQ boards in your computer.

Detailed specifications of the PCI-1409 and PXI-1409 are in Appendix A, *Specifications*.

### **Using PXI with CompactPCI**

Using PXI-compatible products with standard CompactPCI products is an important feature provided by the *PXI Specification*, Revision 1.0. If you use a PXI-compatible plug-in device in a standard CompactPCI chassis, you will be unable to use PXI-specific functions, but you can still use the basic plug-in device functions. For example, the RTSI bus on your PXI-1409 device is available in a PXI chassis, but not in a CompactPCI chassis.

The CompactPCI specification permits vendors to develop sub-buses that coexist with the basic PCI interface on the CompactPCI bus. Compatible operation is not guaranteed between CompactPCI devices with different sub-buses nor between CompactPCI devices with sub-buses and PXI. The standard implementation for CompactPCI does not include these sub-buses. Your PXI-1409 device will work in any standard CompactPCI chassis adhering to the *PICMG 2.0 R2.1 CompactPCI* core specification using the 64-bit definition for J2.

PXI specific features are implemented on the J2 connector of the CompactPCI bus. Table 1-1 lists the J2 pins your PXI-1409 device uses. Your PXI device is compatible with any CompactPCI chassis with a sub-bus that does not drive these lines. Even if the sub-bus is capable of driving these lines, the PXI device is still compatible as long as those pins on the sub-bus are disabled by default and not ever enabled. Damage may result if these lines are driven by the sub-bus.

 Table 1-1.
 Pins Used by the PXI-1409 Device

PXI-1409 Signal	PXI Pin Name	PXI J2 Pin Number
RTSI Trigger <06>	PXI Trigger <06>	B16, A16, A17, A18, B18, C18, E18

### **Software Programming Choices**

Using NI-IMAQ, the National Instruments image acquisition driver software, you can program your IMAQ board to acquire and save images. You can use NI-IMAQ with other National Instruments software for a complete image acquisition and analysis solution, as shown in Figure 1-1. NI-IMAQ works with LabVIEW and LabWindows/CVI, as well as conventional programming languages. National Instruments IMAQ Vision adds powerful image processing and analysis to these programming environments. You can also use IMAQ Vision Builder to quickly and easily prototype your IMAQ image analysis applications.

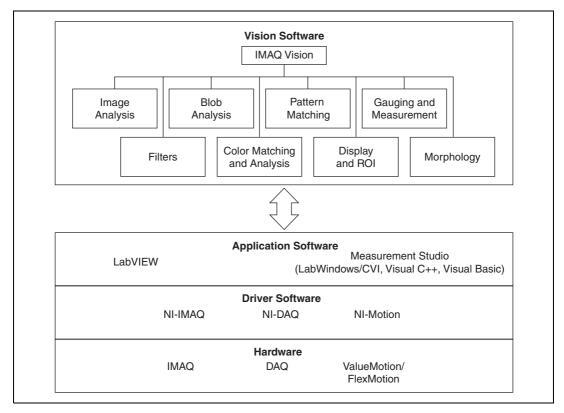


Figure 1-1. The Relationship between the Programming Environment, NI-IMAQ, and Your Hardware

#### **NI-IMAQ Driver Software**

The NI-IMAQ driver software is included with your IMAQ device. NI-IMAQ has an extensive library of functions that you can call from your application programming environment. These functions include routines for video configuration, image acquisition (continuous and single-shot), memory buffer allocation, trigger control, and board configuration, as shown in Figure 1-2.

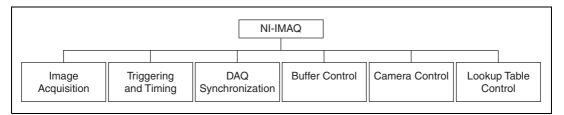


Figure 1-2. NI-IMAQ Functions

The NI-IMAQ driver software performs all of the functions required for acquiring and saving images. The NI-IMAQ software does not perform any image analysis. For image analysis functionality, refer to the *National Instruments IMAQ Vision* section in this chapter.

NI-IMAQ has both high-level and low-level functions for maximum flexibility and performance. Examples of high-level functions include the functions to acquire images in single-shot or continuous mode. An example of a low-level function is configuring an image sequence, since it requires advanced understanding of your IMAQ device and image acquisition.

NI-IMAQ internally resolves many of the complex issues between the computer and your IMAQ device, such as programming interrupts and DMA controllers.

NI-IMAQ is also the interface path between LabVIEW, LabWindows/CVI, or a conventional programming environment and your IMAQ device. The NI-IMAQ software kit includes a series of libraries for image acquisition for LabVIEW and Measurement Studio, which contains libraries for LabWindows/CVI, Visual C++, and Visual Basic. These libraries are functionally equivalent to the NI-IMAQ software.

#### **National Instruments IMAQ Vision**

IMAQ Vision is an image acquisition, processing, and analysis library of more than 200 functions for grayscale, color, and binary image display, image processing, pattern matching, shape matching, blob analysis, gauging, and measurement.

You can use IMAQ Vision functions directly or in combination for unique image processing. With IMAQ Vision you can acquire, display, manipulate, and store images as well as perform image analysis, processing, and interpretation. Using IMAQ Vision, an imaging novice or expert can perform graphical programming of the most basic or complicated image applications without knowledge of any algorithm implementations.

IMAQ Vision is available for LabVIEW and Measurement Studio, which includes support for LabWindows/CVI, Visual C++, and Visual Basic.

#### **IMAQ Vision Builder**

IMAQ Vision Builder is an interactive prototyping tool for machine vision and scientific imaging developers. With IMAQ Vision Builder, you can prototype vision software quickly or test how various vision image processing functions work.

As shown in Figure 1-3, IMAQ Vision Builder generates a Builder file, which is a text description that contains a recipe of the machine vision and image processing functions. This Builder file provides a guide you can use for developing applications with IMAQ Vision in LabVIEW or Measurement Studio.

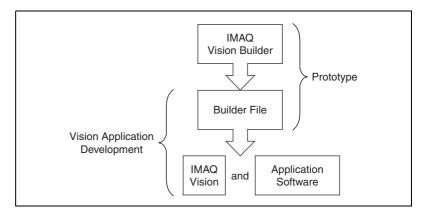


Figure 1-3. IMAQ Vision Builder and Application Development Tools

### **Integration with DAQ**

Any platform that supports NI-IMAQ also supports NI-DAQ and a variety of National Instruments DAQ boards, allowing your IMAQ device and NI-IMAQ development to integrate with National Instruments DAQ products.

#### **Vision and Motion**

With National Instruments IMAQ hardware and IMAQ Vision pattern matching software you can quickly and accurately locate objects in instances where objects vary in size, orientation, focus, and even when the part is poorly illuminated. Use National Instruments high-performance stepper and servo motion control products with pattern matching software in inspection and guidance applications such as locating alignment markers on semiconductor wafers, guiding robotic arms, inspecting the quality of manufactured parts, and locating cells.

# **Configuration and Installation**

This chapter lists what you need to get started acquiring images with your IMAQ device; describes optional equipment and custom cables; and explains how to unpack, configure, and install your IMAQ device.

### What You Need to Get Started

10	To set up and use your 1409 device, you will need the following:		
	One of the following 1409 devices:  - PCI-1409  - PXI-1409		
	Getting Started with Your IMAQ System		
	NI-IMAQ release notes		
	IMAQ PCI/PXI-1409 User Manual		
	NI-IMAQ for Windows 2000/NT/Me/9x and online documentation		
	Optional software packages and documentation:		
	<ul> <li>IMAQ Vision for LabVIEW or Measurement Studio (LabWindows/CVI, Visual C++, Visual Basic)</li> </ul>		
	<ul> <li>IMAQ Vision Builder</li> </ul>		
	– LabVIEW		
	- Measurement Studio (LabWindows/CVI, Tools for Visual Basic)		
	IMAQ BNC-1 shielded, 75 $\Omega$ BNC cable for VIDEO0 (included with the 1409 device)		
	BNC-to-RCA adapter (included with your 1409 device)		

Your Pentium-based PCI, PXI, or CompactPCI computer runni			
Windows 2000, Windows NT, Windows Me, Windows 98, or			
Windows 95			





**Note** The IMAQ PCI-1409 and PXI-1409 devices rely on your computer's PCI interface chipset for the highest throughput to system memory. For the best results, your computer should have a Pentium or better processor and an Intel 430 or 440 series or compatible PCI interface chipset.

### **Optional Equipment**

National Instruments offers a variety of products for use with your PCI/PXI-1409 board, including the following cables and other National Instruments products:

- IMAQ 6822 BNC breakout box and cable for trigger and additional camera support
- RTSI bus cables for connecting the 1409 device to other IMAQ or DAQ hardware
- Other National Instruments DAQ devices for enhanced triggering, timing, or input/output

For more specific information about these products, refer to your National Instruments catalog or Web site, or call the office nearest you.

### **How to Set up Your IMAQ System**

Use Figure 2-1 as a guide while you install your software and hardware, configure your hardware, and begin using NI-IMAQ in your application programs.

Follow the instructions in the *Getting Started with Your IMAQ System* document to install your NI-IMAQ software and IMAQ hardware.

If you will be accessing the NI-IMAQ device drivers through LabVIEW, you should read the NI-IMAQ release notes and the *NI-IMAQ User Manual* to help you get started.

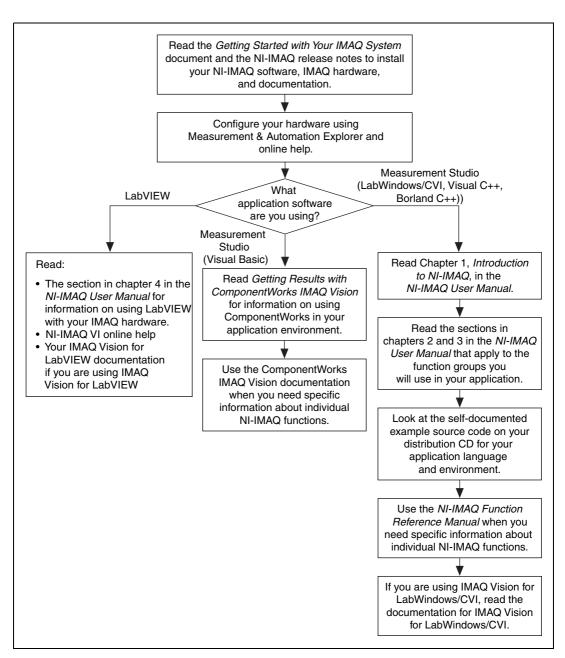


Figure 2-1. How to Set up Your IMAQ System

### Unpacking

Your 1409 device is shipped in an antistatic package to prevent electrostatic damage to the board. Electrostatic discharge can damage several components on the board. To avoid such damage in handling the board, take the following precautions:

- Ground yourself via a grounding strap or by holding a grounded object.
- Touch the antistatic package to a metal part of your computer chassis before removing the board from the package.
- Remove the board from the package and inspect the board for loose components or any other signs of damage. Notify National Instruments if the board appears damaged in any way. Do *not* install a damaged board in your computer.
- *Never* touch the exposed pins of connectors.

### **Board Configuration**

This section describes how to configure the VIDEO0 input mode on the 1409 device.

All other configuration options are software configurable.

Figure 2-2 shows the locations of user-configurable jumpers and switches as well as factory-default settings on the PCI-1409.

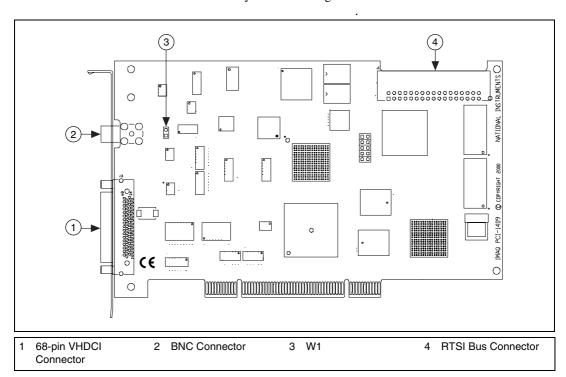


Figure 2-2. PCI-1409 Parts Locator Diagram

### **VIDEOO Input Mode**

VIDEO0 has two different input sources via a BNC connector or a 68-pin VHDCI port and two different input modes—referenced single-ended (RSE) and differential (DIFF) input. When you use the BNC input for VIDEO0, set the input mode to RSE (W1 populated). When you use the 68-pin VHDCI port for VIDEO0, set the input mode for either RSE or DIFF.

When in RSE mode, the video input uses one analog input line, which connects to the video multiplexer circuitry. The negative input to the video multiplexer is tied internally to analog ground. When in DIFF mode, the video input uses two analog input signals. One signal connects to the positive input of the video multiplexer circuitry while the other input signal connects to the negative input of the video multiplexer circuitry. Jumper W1 controls the input mode selection, as shown in Figure 2-3. Unpopulating W1 configures VIDEO0 for DIFF mode. Populating W1 configures VIDEO0 for RSE mode.

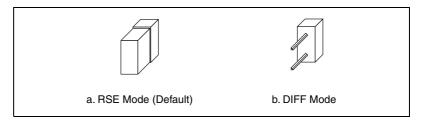


Figure 2-3. Configuring VIDEO0 with Jumper W1

Video channels 1, 2, and 3 are always in differential mode. To take an RSE measurement on these channels, tie the negative terminal of the connector to ground (Pins 26 or 60 on the 68-pin VHDCI connector). See Chapter 4, *Signal Connections*, for more information on pin assignments.

### Installation



**Note** You must install the NI-IMAQ driver software before installing your 1409 device. For information on how to install NI-IMAQ, please see the *Getting Started with Your IMAQ System* document and your NI-IMAQ release notes.

#### ♦ PCI-1409

You can install the PCI-1409 in any available PCI expansion slot in your computer. However, to achieve the best noise performance, you should leave as much room as possible between the PCI-1409 and other boards and hardware. The following are general instructions, but consult your computer user manual or technical reference manual for specific instructions and warnings.

1. Turn off and unplug your computer.



**Warning** To protect both yourself and the computer from electrical hazards, the computer should remain off and unplugged until you finish installing the 1409 device.

- 2. Follow the electrostatic discharge guidelines in the *Unpacking* section of this chapter.
- Remove the cover of your computer.
- 4. Make sure there are no lighted LEDs on your motherboard. If any are lit, wait until they go out before continuing your installation.
- 5. Touch the metal part of the power supply case inside the computer to discharge any static electricity that might be on your clothes or body.
- 6. Select any available PCI expansion slot.
- Locate the metal bracket that covers the cut-out in the back panel of the chassis for the slot you have selected. Remove and save the bracket-retaining screw and the bracket cover.
- 8. Line up the PCI-1409 with the 68-pin VHDCI and BNC connectors near the cut-out on the back panel. Slowly push down on the top of the PCI-1409 until its card-edge connector is resting on the expansion slot receptacle. Using slow, evenly distributed pressure, press the PCI-1409 straight down until it seats in the expansion slot.
- Reinstall the bracket-retaining screw to secure the PCI-1409 to the back panel rail.
- 10. Check the installation.
- 11. Replace the computer cover.

Your PCI-1409 is now installed.

#### ♦ PXI-1409

You can install a PXI-1409 in any available 5 V peripheral slot in your PXI or CompactPCI chassis.



**Note** The PXI-1409 has connections to several reserved lines on the CompactPCI J2 connector. Before installing a PXI-1409 in a CompactPCI system that uses J2 connector lines for purposes other than PXI, see *Using PXI with CompactPCI*, in Chapter 1, *Introduction*, of this manual.

- 1. Turn off and unplug your PXI or CompactPCI chassis.
- 2. Choose an unused PXI or CompactPCI 5 V peripheral slot. Install the PXI-1409 in a slot that supports bus arbitration or bus-master cards. PXI-compliant chassis must have bus arbitration for all slots.
- 3. Remove the filler panel for the peripheral slot you have chosen.
- 4. Touch a metal part on your chassis to discharge any static electricity that might be on your clothes or body.
- 5. Insert the PXI-1409 in the selected 5 V slot. Use the injector/ejector handle to fully inject the device into place.
- 6. Screw the front panel of the PXI-1409 to the front panel mounting rails of the PXI or CompactPCI chassis.
- 7. Visually verify the installation.
- 8. Plug in and turn on the PXI or CompactPCI chassis.

Your PXI-1409 is now installed.

## **Hardware Overview**

This chapter presents an overview of the hardware functions on your PCI/PXI-1409 board and explains the operation of each functional unit making up the PCI/PXI-1409.

### **Functional Overview**

The PCI/PXI-1409 features a flexible, high-speed data path optimized for the acquisition and formatting of video data from analog cameras. The 1409 device can acquire from RS-170/NTSC, CCIR/PAL, VGA, and progressive scan cameras, as well as from non-standard cameras such as line scan cameras. The 1409 device digitizes analog video signals to 8 or 10 bits of resolution at sampling frequencies up to 40 MHz.

The 1409 device has a factory calibrated gain circuit to improve measurement accuracy and board-to-board consistency. It uses a PCI interface for high-speed data transfer, 16 MB of SDRAM for data buffering, and region-of-interest control circuitry for optimizing the data transfer. The 16 MB of SDRAM also allows you to acquire entire images into on-board memory when necessary. The 1409 device includes four external triggers, four camera control signals, seven RTSI bus triggers, and six video synchronization signals.

The block diagram in Figure 3-1 illustrates the key functional units of the PCI/PXI-1409.

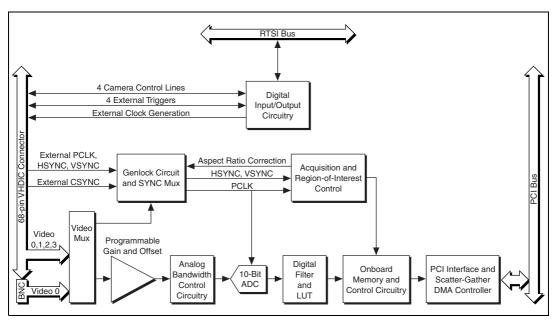


Figure 3-1. 1409 Device Block Diagram

### Video Mux

The video multiplexer routes one of the four AC-coupled video inputs to the 10-bit ADC circuitry. The input impedance at the input to the board is 75  $\Omega$ .

### **Programmable Gain and Offset**

The PCI/PXI-1409 uses programmable gain and offset circuitry to optimize the input signal range.

### **Analog Bandwidth Control Circuitry**

You can select either the full bandwidth of 30 MHz or a reduced bandwidth of 9 MHz. The 9 MHz bandwidth setting is available using a 5th order Butterworth lowpass filter.

#### 10-Bit ADC

The 10-bit ADC digitizes the conditioned video signal.

### **Digital Filter and LUT**

The digital filter removes chrominance from a composite color video signal that conforms to either PAL or NTSC. The output of the digital filter passes through the  $1024 \times 10$ -bit lookup table (LUT). You can configure the LUT to implement simple imaging operations such as contrast enhancement, data inversion, gamma correction, or other user-defined transfer functions.

### **Onboard Memory**

The PCI/PXI-1409 comes with 16 MB of SDRAM for temporary storage of the image data being transferred to the system memory through the PCI bus. The memory can store multiple image buffers.

#### **Scatter-Gather DMA Controllers**

The PCI/PXI-1409 uses three independent onboard direct memory access (DMA) controllers. The DMA controllers transfer data between the onboard SDRAM memory buffer and the PCI bus. Each of these controllers supports scatter-gather DMA, which allows the controllers to reconfigure on the fly. Therefore, the PCI/PXI-1409 can perform continuous image transfers directly to either contiguous or fragmented memory buffers.

#### **PCI** Interface

The PCI/PXI-1409 implements the PCI interface with a National Instruments custom application-specific integrated circuit (ASIC), the PCI MITE. The PCI interface can transfer data at a maximum rate of 132 MB/s in bus master mode.

#### **Genlock Circuit and SYNC Mux**

The genlock circuit receives the incoming video signal and generates PCLK, HSYNC, and VSYNC signals for use by the acquisition and control circuitry. The 1409 device can lock to the standard RS-170/NTSC and CCIR/PAL video signals as well as progressive scan and VGA  $(640\times480~{\rm resolution})$  signals. The genlock circuit on the 1409 device can also lock to external HSYNC and VSYNC or CSYNC signals.

### Acquisition and Region-of-Interest (ROI) Control

The acquisition and region-of-interest control circuitry routes the active pixels from the 10-bit ADC to the onboard memory. The PCI/PXI-1409 can perform ROI and scaling on all video lines. Pixel and line scaling transfers certain multiples (two, four, or eight) of pixels and lines to onboard memory.

#### **RTSI Bus**

The seven trigger lines on the RTSI bus provide a flexible interconnection scheme between multiple PCI/PXI-1409 boards as well as between any National Instruments DAQ or Motion device and the PCI/PXI-1409.

### **Digital Input/Output Circuitry**

The digital input/output circuitry routes, monitors, and drives the external trigger lines, RTSI bus lines, and camera control lines. You can use the trigger lines to start or stop an acquisition on a rising or falling edge. In addition, you can map onboard signals such as HSYNC, VSYNC, ACQUISTION\_IN\_PROGRESS, and ACQUISITION\_DONE to these lines. The camera control lines provide a means to generate deterministic signals for triggering cameras, strobe lights, or other timing-critical applications. This module also contains an external clock generation circuit. You can use this external clock as the source clock for a line scan camera.

### **Acquisition Modes**

The 1409 device supports five video acquisition modes.

- Standard Mode—In standard mode, the 1409 device receives an
  incoming composite video signal from the external BNC or 68-pin
  VHDCI connector and generates CSYNC, HSYNC, VSYNC, and
  PCLK signals. The generated CSYNC signal is output on the VHDCI
  connector to synchronize other image acquisition boards or cameras.
- CSYNC External Mode—In CYSNC external mode, the 1409 device receives an incoming video signal (composite or luminance) and an external CSYNC signal from the external connector and generates HSYNC, VSYNC, and PCLK signals.

- External Lock Mode—In external lock mode, the 1409 device receives HSYNC, VSYNC, and PCLK signals from the camera and uses these signals to acquire the video signals directly. You can also use this mode to acquire from a line scan camera.
- External HSYNC/VSYNC Mode—In external HSYNC/VSYNC mode, the 1409 device receives the external HSYNC and VSYNC from the connector and internally generates the PCLK signal. The device's genlock circuitry locks to the external HSYNC and VSYNC signals. You can use this mode to acquire from VGA monitors (640 x 480 resolution).
- External HSYNC/VSYNC (HLOCK only) mode—In external HSYNC/VSYNC (HLOCK only) mode, the 1409 device receives the external HSYNC and VSYNC signals and internally generates the PCLK signal. In this mode, the device's genlock circuitry uses only the HSYNC signal for locking. You can use this mode to acquire from asynchronously-reset cameras which output a continuous HSYNC.



**Note** Connect a FIELD signal to TRIG3 when the 1409 device is in external lock mode with an interlaced camera.

### **Analog Front End Considerations**

The analog front end of the IMAQ PCI/PXI-1409 device features a calibrated gain circuit, programmable DC-restore circuit, and 10-bit ADC as shown in Figure 3-2.



Figure 3-2. IMAQ PCI/PXI-1409 Analog Front End

#### 10-bit/8-bit Mode

The 1409 device digitizes the incoming video signal to 10 bits of resolution at all times. In 10-bit mode, the 1409 device has four fixed, full-scale ranges where the gain for each range is calibrated. The nominal full-scale ranges are 0.20, 0.35, 0.70, and 1.40 V. As a result, the gain is not continuously variable in this mode. To maintain compatibility with other IMAQ analog devices, the 1409 device has an 8-bit mode, in which the 10-bit data from the ADC is converted to 8-bit data in the lookup table (LUT) after gain correction and any digital filtering has occurred.

# **Signal Connections**

This chapter describes cable connections for the PCI-1409 and PXI-1409 devices.

### **BNC Connector**

The BNC external connector supplies an immediate connection to the 1409 device VIDEO0 input. Use the 2 m BNC cable shipped with the PCI/PXI-1409 to connect a camera to VIDEO0. You cannot use this connection with VIDEO0 on the 68-pin VHDCI I/O connector. You can configure the BNC connector only for RSE mode.



**Note** Verify that Jumper W1 is installed when using the BNC input.

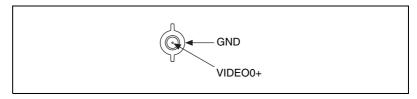


Figure 4-1. BNC Connector Pin Assignment

### I/O Connector

The 68-pin VHDCI connector connects to all video signals (VIDEO0, VIDEO1, VIDEO2, and VIDEO3), the external digital I/O lines, triggers, and external signals. To access these connections, you can build your own custom cable or use one of the optional cables from National Instruments. Figure 4-2 shows the pinout of the 68-pin VHDCI connector.



**Note** Do *not* use the VIDEO0 connection on the 68-pin VHDCI connector when using the BNC connection.

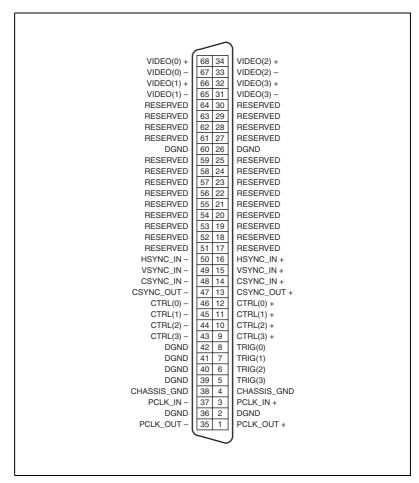


Figure 4-2. I/O Connector Pin Assignments

### I/O Connector Signal Connection Descriptions

Table 4-1 describes each signal connection on the 68-pin VHDCI connector.

Table 4-1. I/O Connector Signals

Signal Name	Description
VIDEO0±	VIDEO0± allows for a DIFF or RSE connection to video channel 0. To operate in RSE mode, connect VIDEO0– to GND. When you use VIDEO0+ or VIDEO0–, you must disconnect the BNC connector.
VIDEO<31>±	VIDEO<31>± allows for a DIFF or RSE connection to video channels 1, 2, and 3. To operate in RSE mode, connect VIDEO– to GND.
PCLKIN±	Use PCLKIN± when the 1409 device is in external lock mode. In this mode, PCLKIN represents the A/D sampling clock. You can select PCLKIN to be either TTL or RS-422 mode and program its polarity through software. In RS-422 mode, both PCLKIN+ and PCLKIN- receive the PCLK signal.
PCLKOUT±	Use PCLKOUT± when your camera requires an external pixel clock source. The 1409 device can generate variable pixel clock frequencies between 500 kHz and 40 MHz. You can set PCLKOUT± through your software in TTL and RS-422 modes.
HSYNCIN±	Use HSYNCIN± when the 1409 device is in external lock mode. HSYNC is a synchronization pulse produced at the beginning of each video scan line that keeps a video monitor's horizontal scan rate in step with the transmission of each new line. You can set HSYNCIN to be either TTL or RS-422 mode and program its polarity through software. In RS-422 mode, both HSYNCIN+ and HSYNCIN- receive the HSYNC signal.
VSYNCIN±	Use VSYNCIN± when the 1409 device is in external lock mode. VSYNC is a synchronization pulse generated at the beginning of each video frame that tells the video monitor when to start a new field. You can set VSYNCIN to be either TTL or RS-422 mode and program its polarity through software. In RS-422 mode, both VSYNCIN+ and VSYNCIN- receive the VSYNC signal.
CSYNCIN±	Use CSYNCIN± when the 1409 device is in CSYNC external mode. CSYNC is a signal consisting of horizontal sync pulses, vertical sync pulses, and equalizing pulses only. You can set CSYNCIN to be either TTL or RS-422 mode and program its polarity through software. In RS-422 mode, both CSYNCIN+ and CSYNCIN- receive the CSYNC signal.
CSYNCOUT	CSYNCOUT is a TTL output of the internal CSYNC signal. In CSYNC external mode, CSYNCOUT maps directly to CSYNCIN. In standard mode, the synchronization circuitry of the 1409 device generates CSYNCOUT.

Table 4-1. I/O Connector Signals (Continued)

Signal Name	Description
TRIG<30>	Triggers <30> are TTL I/O lines used to start or stop an acquisition or output an acquisition status. You can program the triggers to be rising- or falling-edge sensitive. You can also program the triggers to be programmatically asserted or unasserted similar in function to a digital I/O line or to contain internal status signals (by using the onboard events) or specific pulse widths.
CTRL<30>±	Use the control lines on the PCI-1409 to control camera features and timing information. Either static or dynamic, TTL or differential, signals can be generated on these lines to perform such functions as generating integration or shutter pulses to the cameras.
GND	GND is a direct connection to digital GND on the 1409 device.
CHASSIS_GND	CHASSIS_GND is a direct connection to the computer's chassis, which is grounded through the power cord.



# **Specifications**

This appendix lists the specifications of the PCI-1409 and PXI-1409 devices. These specifications are typical at 25 °C, unless otherwise stated.

### **Formats Supported**

RS-170/NTSC	
	(Interlaced mode: 60 fields/s)
CCIR/PAL	. 50 Hz
	(Interlaced mode: 50 fields/s)
VGA	. 60 Hz, $640 \times 480$ resolution
Variable scan	. Programmable

### **Video Input**

Quantity	Four monochrome
Input impedance	.75 Ω ±1%
VIDE00	RSE (BNC), RSE or DIFF (VHDCI)
VIDEO<30>	RSE or DIFF (VHDCI)
Frequency response	.30 MHz (-3 dB) typ
Digital Antichrominance filter	Programmable (disabled, 3.58 MHz notch filter, or 4.43 MHz notch filter)
Filter characteristics	Attenuation at notch frequency > 30 dB

	Input range (black to white)	700 mV (calibrated) 200 mV to 1.40 V full scale	
	Accuracy	±1.5% of reading	
	Temperature drift	< 250 ppm/°C	
A/D Conversion			
•	Gray levels	1024 (10-bit)	
	Differential nonlinearity	±1 LSB max	
	RMS noise	< 0.5 LSB rms	
	Signal-to-noise ratio	56 dB typ	
	Sampling rate	2 MHz to 40 MHz, externally clocked	
	Pixel aspect ratio	Programmable ±5% of nominal	
Internal Pixel Clock			
	Frequencies range	11.6 to 25.8 MHz	
	Pixel ratio for standard video sources	±5%	
	Pixel jitter	< 2 ns peak	
PCI Interface			
	PCI initiator (master) capability	Supported	
	PCI target (slave) capability	Supported	
	Data path	32 bits	
	Card voltage	5 V only	
	Card type	32-bit half-size card	
	Parity generation/checking, error reporting	Supported	
	Target decode speed	Medium (1 clock)	

	Target fast back-to-back capability	Supported
	Resource locking	Supported as a master and slave
	PCI interrupts	Interrupts passed on INTA# signal
	Base address registers	BAR0 (16 KB) BAR1 (64 KB)
	Expansion ROM	4 KB
	PCI master performance	
	Ideal	133 Mbytes/s
	Sustained	100 Mbytes/s
Power Requireme	nts	
	Voltage	+5 V (1.5 A) +12 V (100 mA) -12 V (50 mA)
Physical		
	Dimensions	
	PCI-1409	10.7 by 17.5 cm (4.2 by 6.9 in.)
	PXI-1409	10 by 16 cm (3.9 by 6.3 in.)
	Weight	
	PCI-1409	0.127 kg (0.28 lb)
	PXI-1409	0.172 kg (0.38 lb)
Environment		
	Operating temperature	0 to 55 °C
	Storage temperature	–20 to 70 °C
	Relative humidity	10 to 90%, noncondensing

Electromagn	etic Com	patibility

EMC/EMI	CE, C-Tick, and FCC Part 15
	(Class A) Compliant
Electrical Emissions	EN 55011 Class A at 10 meters. FCC Part 15A above 1 GHz
Electrical Immunity	Evaluated to EN 61326:1998,



**Note** This device should only be operated with shielded cable for full EMC and EMI compliance. See the *Compliance* section of this manual and the *Declaration of Conformity* included in your kit for any additional regulatory compliance information.

Functional shock (PXI only)	MIL-T-28800 E Class 3 (per
	Section 4.5.5.4.1) Half-sine shock
	pulse, 11 ms duration, 30 g peak,
	30 shocks per face
Operational random	
vibration (PXI only)	5 to 500 Hz, 0.31 grms, 3 axes
Nonoperational random	

vibration (PXI only).....5 to 500 Hz, 2.5 grms, 3 axes



**Note** Random vibration profiles were developed in accordance with MIL-T-28800E and MIL-STD-810E Method 514. Test levels exceed those recommended in MIL-STD-810E for Category 1 (Basic Transportation, Figures 514.4-1 through 514.4-3).

B

## **Custom Cables**

This appendix lists specifications for building custom cables for your 1409 device.

### **Cable Specification**

National Instruments offers cables and accessories for you to connect to video sources, trigger sources, or synchronization sources. However, if you want to develop your own cables, the following guidelines must be met:

- For the video inputs, use a 75  $\Omega$  shielded coaxial cable.
- For the digital triggers and synchronization signals, twisted pairs for each signal yield the best result.

For information on connector pin assignments, see the *I/O Connector* section in Chapter 4, *Signal Connections*.

Connector specifications include:

• Video and sync signals 75  $\Omega$  impedance

• Trigger signals TTL

• Type 75  $\Omega$  BNC or

68-pin VHDCI receptacle



# **Technical Support Resources**

#### **Web Support**

National Instruments Web support is your first stop for help in solving installation, configuration, and application problems and questions. Online problem-solving and diagnostic resources include frequently asked questions, knowledge bases, product-specific troubleshooting wizards, manuals, drivers, software updates, and more. Web support is available through the Technical Support section of ni.com

#### NI Developer Zone

The NI Developer Zone at ni.com/zone is the essential resource for building measurement and automation systems. At the NI Developer Zone, you can easily access the latest example programs, system configurators, tutorials, technical news, as well as a community of developers ready to share their own techniques.

#### **Customer Education**

National Instruments provides a number of alternatives to satisfy your training needs, from self-paced tutorials, videos, and interactive CDs to instructor-led hands-on courses at locations around the world. Visit the Customer Education section of ni.com for online course schedules, syllabi, training centers, and class registration.

### System Integration

If you have time constraints, limited in-house technical resources, or other dilemmas, you may prefer to employ consulting or system integration services. You can rely on the expertise available through our worldwide network of Alliance Program members. To find out more about our Alliance system integration solutions, visit the System Integration section of ni.com

### **Worldwide Support**

National Instruments has offices located around the world to help address your support needs. You can access our branch office Web sites from the Worldwide Offices section of ni.com. Branch office Web sites provide up-to-date contact information, support phone numbers, e-mail addresses, and current events.

If you have searched the technical support resources on our Web site and still cannot find the answers you need, contact your local office or National Instruments corporate. Phone numbers for our worldwide offices are listed at the front of this manual.

# **Glossary**

Prefix	Meanings	Value
p-	pico-	10-12
n-	nano-	10-9
μ-	micro-	10-6
m-	milli-	10-3
k-	kilo-	103
M-	mega-	10 <sup>6</sup>
G-	giga-	109

#### Numbers/Symbols

% percent

+ positive of, or plus

negative of, or minus

/ per

+5V 5 V signal

± plus or minus

 $\Omega \hspace{1cm} \text{ohm}$ 

A

A Amperes.

A/D Analog-to-digital.

AC Alternating current.

acquisition window 
The image size specific to a video standard or camera resolution.

active line region The region of lines actively being stored. Defined by a line start (relative to

the vertical synchronization signal (VSYNC)) and a line count.

active pixel region The region of pixels actively being stored. Defined by a pixel start [relative

to the horizontal synchronization signal(HSYNC)] and a pixel count.

ADC Analog-to-digital converter. An electronic device, often an integrated

circuit, that converts an analog voltage to a digital value.

address Value that identifies a specific location (or series of locations) in memory.

ANSI American National Standards Institute.

antichrominance filter Removes the color information from the video signal.

API Application programming interface.

area A rectangular portion of an acquisition window or frame that is controlled

and defined by software.

array Ordered, indexed set of data elements of the same type.

ASIC Application-Specific Integrated Circuit. A proprietary semiconductor

component designed and manufactured to perform a set of specific

functions for specific customer needs.

aspect ratio The ratio of a picture or image's width to its height.

B

b Bit. One binary digit, either 0 or 1.

Byte. Eight related bits of data, an eight-bit binary number. Also denotes

the amount of memory required to store one byte of data.

back porch The area of the video signal between the rising edge of the horizontal

synchronization signal (HSYNC) and the active video information.

black reference level The level that represents the darkest an image can get. See also white

reference level.

buffer Temporary storage for acquired data.

bus A group of conductors that interconnect individual circuitry in a computer,

such as the PCI bus; typically the expansion vehicle to which I/O or other

devices are connected.

C

C Celsius.

cache High-speed processor memory that buffers commonly used instructions or

data to increase processing throughput.

CCIR Comite Consultatif International des Radiocommunications. A committee

that developed standards for video signals. Also used to describe signals,

boards, and cameras that adhere to the CCIR standards.

chroma The color information in a video signal.

chrominance See chroma.

CMOS Complementary metal-oxide semiconductor.

CompactPCI Refers to the core specification defined by the PCI Industrial Computer

Manufacturer's Group (PICMG).

conversion device Device that transforms a signal from one form to another. For example,

analog-to-digital converters (ADCs) for analog input and digital-to-analog

converters (DACs) for analog output.

CPU Central processing unit.

CSYNC Composite synchronization signal. Signals in a color video system that

multiplex all picture information into a single signal, such as NTSC, PAL,

or SECAM.

D

D/A Digital-to-analog.

DAC Digital-to-analog converter. An electronic device, often an integrated

circuit, that converts a digital number into a corresponding analog voltage

or current.

DAQ Data acquisition. (1) Collecting and measuring electrical signals from

sensors, transducers, and test probes or fixtures and inputting them to a computer for processing. (2) Collecting and measuring the same kinds of electrical signals with A/D or DIO boards plugged into a computer, and possibly generating control signals with D/A and/or DIO boards in the

same computer.

dB Decibel. The unit for expressing a logarithmic measure of the ratio of two

signal levels:  $dB = 20\log_{10} V1/V2$ , for signals in volts.

DC Direct current.

default setting A default parameter value recorded in the driver. In many cases, the default

input of a control is a certain value (often 0).

DMA Direct memory access. A method by which data can be transferred between

computer memory and a device or memory on the bus while the processor does something else. DMA is the fastest method of transferring data

to/from computer memory.

DRAM Dynamic RAM.

driver Software that controls a specific hardware device, such as an IMAQ or

DAQ device.

dynamic range The ratio of the largest signal level a circuit can handle to the smallest

signal level it can handle (usually taken to be the noise level), normally

expressed in decibels.

E

EEPROM Electrically erasable programmable read-only memory. ROM that can be

erased with an electrical signal and reprogrammed.

external trigger A voltage pulse from an external source that triggers an event such as A/D

conversion.

F

field For an interlaced video signal, a field is half the number of horizontal lines

needed to represent a frame of video. The first field of a frame contains all the odd-numbered lines, the second field contains all of the even-numbered

lines.

FIFO First-in first-out memory buffer. The first data stored is the first data sent

to the acceptor. FIFOs are used on IMAQ devices to temporarily store

incoming data until that data can be retrieved.

flash ADC An ADC whose output code is determined in a single step by a bank of

comparators and encoding logic.

frame A complete image. In interlaced formats, a frame is composed of two fields.

front porch The area of a video signal between the start of the horizontal blank and the

start of the horizontal synchronization signal (HSYNC).

ft Feet.

function A set of software instructions executed by a single line of code that may

have input and/or output parameters and returns a value when executed.

G

gamma The nonlinear change in the difference between the video signal's

brightness level and the voltage level needed to produce that brightness.

genlock The process of synchronizing a video source to the signal from a separate

video source. The circuitry aligns the video timing signals by locking together the horizontal, vertical, and color subcarrier frequencies and phases and generates a pixel clock that clocks pixel data into memory for

display or into another circuit for processing.

GUI Graphical user interface. An intuitive, easy-to-use means of

communicating information to and from a computer program by means of graphical screen displays. GUIs can resemble the front panels of instruments or other objects associated with a computer program.

н		
н	r	٠
н		

h Hour.

hardware The physical components of a computer system, such as the circuit boards,

plug-in boards, chassis, enclosures, peripherals, and cables.

HSYNC Horizontal synchronization signal. The synchronization pulse signal

produced at the beginning of each video scan line that keeps a video monitor's horizontal scan rate in step with the transmission of each new

line.

hue Represents the dominant color of a pixel. The hue function is a continuous

function that covers all the possible colors generated using the R, G, and B

primaries. See also RGB.

Hz Hertz. Frequency in units of 1/second.

I/O Input/output. The transfer of data to/from a computer system involving

communications channels, operator interface devices, and/or data

acquisition and control interfaces.

IC Integrated circuit.

IEEE Institute of Electrical and Electronics Engineers.

in. Inches.

INL Integral nonlinearity. A measure of LSB of the worst-case deviation from

the ideal A/D or D/A transfer characteristic of the analog I/O circuitry.

instrument driver A set of high-level software functions, such as NI-IMAQ, that control

specific plug-in computer boards. Instrument drivers are available in several forms, ranging from a function callable from a programming

language to a virtual instrument (VI) in LabVIEW.

interlaced A video frame composed of two interleaved fields. The number of lines in

a field are half the number of lines in an interlaced frame.

interpreter A software utility that executes source code from a high-level language

such as Basic, C or Pascal, by reading one line at a time and executing the

specified operation.

interrupt A computer signal indicating that the CPU should suspend its current task

to service a designated activity.

interrupt level The relative priority at which a device can interrupt.

IRQ Interrupt request. See interrupt.

K

k Kilo. The standard metric prefix for 1,000, or 10<sup>3</sup>, used with units of

measure such as volts, hertz, and meters.

K Kilo. The prefix for 1,024, or 2<sup>10</sup>, used with B in quantifying data or

computer memory.

kbytes/s A unit for data transfer that means 1,000 or 10<sup>3</sup> bytes/s.

Kword 1,024 words of memory.

L

line count The total number of horizontal lines in the picture.

LSB Least significant bit.

luma The brightness information in the video picture. The luma signal amplitude

varies in proportion to the brightness of the video signal and corresponds

exactly to the monochrome picture.

luminance See luma.

LUT Lookup table. Table containing values used to transform the gray-level

values of an image. For each gray-level value in the image, the corresponding new value is obtained from the lookup table.

M

m Meters.

M (1) Mega, the standard metric prefix for 1 million or 10<sup>6</sup>, when used with

units of measure such as volts and hertz (2) Mega, the prefix for 1,048,576,

or 2<sup>20</sup>, when used with B to quantify data or computer memory.

MB Megabyte of memory.

Mbytes/s A unit for data transfer that means 1 million or 10<sup>6</sup> bytes/s.

memory buffer See buffer.

memory window Continuous blocks of memory that can be accessed quickly by changing

addresses on the local processor.

MSB Most significant bit.

MTBF Mean time between failure.

mux Multiplexer. A switching device with multiple inputs that selectively

connects one of its inputs to its output.

N

NI-IMAQ Driver software for National Instruments IMAQ hardware.

noninterlaced A video frame where all the lines are scanned sequentially, instead of

divided into two frames as in an interlaced video frame.

NTSC National Television Standards Committee. The committee that developed

the color video standard used primarily in North America, which uses

525 lines per frame. See also PAL.

number of planes

(in an image)

The number of arrays of pixels that compose the image. A gray-level or pseudo-color image is composed of one plane, while an RGB image is composed of three planes (one for the red component, one for the blue,

and one for the green).

NVRAM Nonvolatile RAM. RAM that is not erased when a device loses power or is

turned off.

0

operating system Base-level software that controls a computer, runs programs, interacts with

users, and communicates with installed hardware or peripheral devices.

P

PAL Phase Alternation Line. One of the European video color standards. PAL

uses 625 lines per frame. See also NTSC.

PCI Peripheral Component Interconnect. A high-performance expansion bus

architecture originally developed by Intel to replace ISA and EISA. PCI

offers a theoretical maximum transfer rate of 132 Mbytes/s.

PCLK Pixel clock signal. Times the sampling of pixels on a video line.

picture aspect ratio The ratio of the active pixel region to the active line region. For standard

video signals like RS-170 or CCIR, the full-size picture aspect ratio

normally is 4/3 (1.33).

pixel Picture element. The smallest division that makes up the video scan line.

For display on a computer monitor, a pixel's optimum dimension is square

(aspect ratio of 1:1, or the width equal to the height).

pixel aspect ratio

The ratio between the physical horizontal size and the vertical size of the

region covered by the pixel. An acquired pixel should optimally be square, thus the optimal value is 1.0, but typically it falls between 0.95 and 1.05,

depending on camera quality.

pixel clock Divides the incoming horizontal video line into pixels.

pixel count The total number of pixels between two horizontal synchronization signals

(HSYNCs). The pixel count determines the frequency of the pixel clock.

PLL Phase-locked loop. Circuitry that provides a very stable pixel clock that is

referenced to another signal, such as an incoming horizontal

synchronization signal (HSYNC).

protocol The exact sequence of bits, characters, and control codes used to transfer

data between computers and peripherals through a communications

channel.

pts Points.

PXI PCI eXtensions for Instrumentation. An open specification that builds on

the CompactPCI specification by adding instrumentation-specific features.

RAM Random-access memory.

relative accuracy A measure in LSB of the accuracy of an ADC; it includes all nonlinearity

and quantization errors but does not include offset and gain errors of the

circuitry feeding the ADC.

resolution (1) The number of rows and columns of pixels. An image composed of m

rows and n columns has a resolution of  $m \times n$ . This image has n pixels along its horizontal axis and m pixels along its vertical axis. (2) The smallest signal increment that can be detected by a measurement system. Resolution can be expressed in bits, proportions, or a percentage of full scale. For example, a system has 12-bit resolution, one part in 4,096

resolution, and 0.0244 percent of full scale.

RGB Color encoding scheme using red, green, and blue (RGB) color information

where each pixel in the color image is encoded using 32 bits: 8 bits for red, 8 bits for green, 8 bits for blue, and 8 bits for the alpha value (unused).

ribbon cable A flat cable in which the conductors are side by side.

ROI Region of interest. (1) An area of the image that is graphically selected

from a window displaying the image. This area can be used focus further processing. (2) A hardware-programmable rectangular portion of the

acquisition window.

ROM Read-only memory.

RS-170 The U.S. standard used for black-and-white television.

RSE Referenced single-ended. All measurements are made with respect to a

common reference measurement system or a ground. Also called a

grounded measurement system.

RTSI bus Real-Time System Integration Bus. The National Instruments timing bus

that connects IMAQ and DAQ boards directly by means of connectors on

top of the boards for precise synchronization of functions.

S

Seconds. S

saturation The amount of white added to a pure color. Saturation relates to the richness

of a color. A saturation of zero corresponds to a pure color with no white

added. Pink is a red with low saturation.

scaling down circuitry Circuitry that scales down the resolution of a video signal.

scatter-gather DMA A type of DMA that allows the DMA controller to reconfigure on-the-fly.

SRAM Static RAM.

StillColor A post-processing algorithm that allows the acquisition of high-quality

color images generated either by an RGB or composite (NTSC or PAL)

camera using a monochrome video acquisition board.

Tells the display where to put a video picture. The horizontal sync indicates sync

the picture's left-to-right placement and the vertical sync indicates

top-to-bottom placement.

system RAM RAM installed on a personal computer and used by the operating system,

as contrasted with onboard RAM.

T

transfer rate The rate, measured in bytes/s, at which data is moved from source to

destination after software initialization and set up operations. The

maximum rate at which the hardware can operate.

trigger Any event that causes or starts some form of data capture.

trigger control and

Circuitry that routes, monitors, and drives external and RTSI bus trigger mapping circuitry

lines. You can configure each of these lines to start or stop acquisition on a

rising or falling edge.

TTL Transistor-transistor logic.

U

UV plane See YIIV. V

V Volts.

value The grayscale intensity of a color pixel computed as the average of the

maximum and minimum red, green, and blue values of that pixel.

VCO Voltage-controlled oscillator. An oscillator that changes frequency

depending on a control signal. Use VCO in a phase-locked loop to generate

a stable pixel clock.

VI Virtual Instrument. (1) A combination of hardware and/or software

elements, typically used with a PC, that has the functionality of a classic stand-alone instrument (2) A LabVIEW software module (VI), which consists of a front panel user interface and a block diagram program.

video line A video line consists of a horizontal synchronization signal, back porch,

active pixel region, and a front porch.

VSYNC Vertical synchronization signal. The synchronization pulse generated at the

beginning of each video field that tells the video monitor when to start a

new field.

W

white reference level The level that defines what is white for a particular video system. See also

black reference level.

Y

YUV A representation of a color image used for the coding of NTSC or PAL

video signals. The luma information is called Y, while the chroma information is represented by two components, U and V representing the

coordinates in a color plane.

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